



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. 10/666,399 Confirmation No. 8955
Applicant: Michael S. Leung
Filed: September 18, 2003
Art Unit: 2814
Examiner: Thao X. Le
Attorney Doc. P0298US-7

Title: MOLDED CHIP FABRICATION METHOD AND APPARATUS

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria VA 22313-1450

RESPONSE TO OFFICE ACTION

Dear Sir:

In response to the office action mailed November 18, 2004,
please amend the above identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the claims are reflected in the listing of which
begins on page 4 of this paper.

Amendments to the Drawings begin on page 11 of this paper.

Remarks begin on page 12 of this paper.